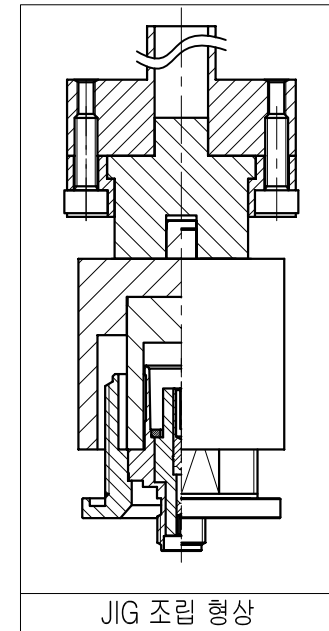
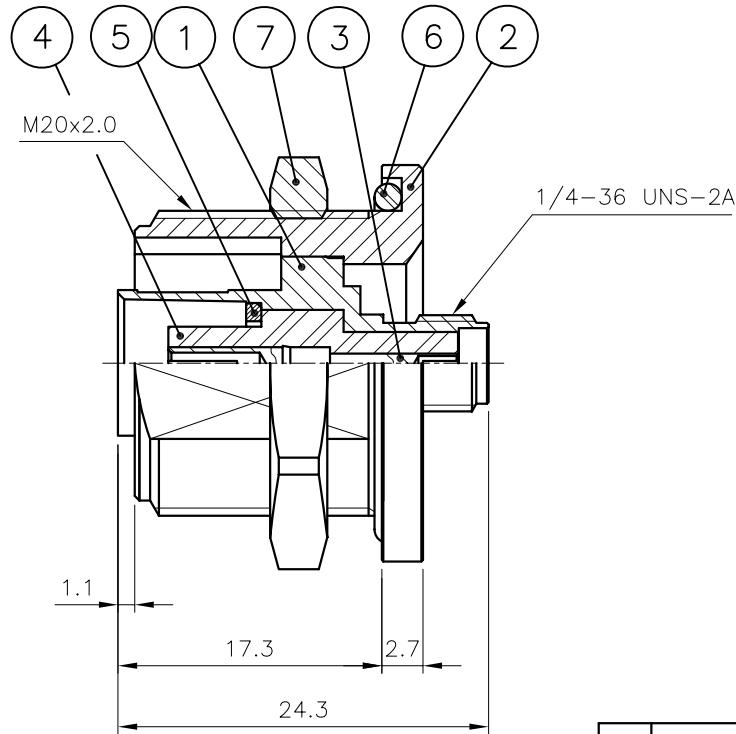
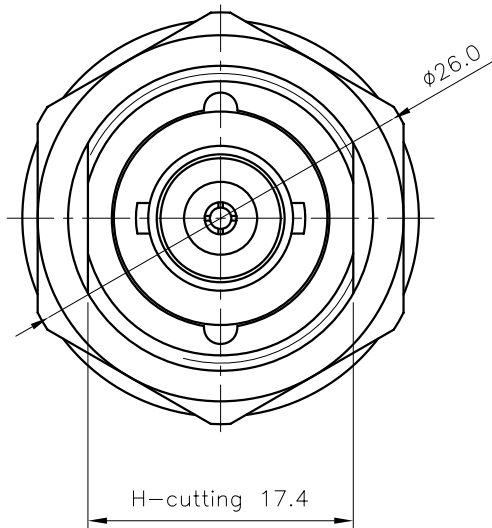


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	G.Y.KIM	I.C.KIM	2017.01.23.



*조립방법

1. ①번 BODY(A)에 ④번 INSULATOR를 조립한다.
2. ①번 BODY(A)에 ⑤번 고정 RING을 조립한다.
3. ④번 INSULATOR에 ③번 PIN을 조립한다.
4. ②번 BODY(B)에 ⑥번 GASKET을 조립한다.
5. ②번 BODY(B)에 ①번 BODY(A)를 CEQ00474-N/1 JIG로 억지끼움 한다.

*좌측면도 참조하여 방향 주의할 것

7	NUT	1	SUS	Passivated	DNT00105-5/1
6	GASKET	1	SILICONE RUB		DGK00145-N/1
5	RING	1	MBsBD C3604BD-F	Nickel Plate	DSR00051-5/1
4	INSULATOR	1	TEFLON		DIN02878-N/1
3	CONTACT	1	BeCu C17300	Gold Plate	DAC03265-5/1
2	BODY (B)	1	SUS	Passivated	DBD04286-5/1 (사급품)
1	BODY (A)	1	MBsBD C3604BD-F	Nickel Plate	DAD00326-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 01. 23.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	C.K.KIM	KJ COMTECH CO.,LTD. TITLE BNC50 (J) BODY/M20 SMA50 (J) BH ADAPTOR
		DRAWN BY	G.Y.KIM	
FINISH		SCALE	UNIT	A4 DWG NO. AD00599-7/1 REVISION I R SHEET 1 of 1
		2/1	mm	